

Description

The CP2302DI uses advanced trench technology to provide excellent RDS(ON), low gate charge and operation with gate voltages as low as 2.5V. This device is suitable for use as a Battery protection or in other Switching application.

General Features

V_{DS} = 20V I_D =2.3A

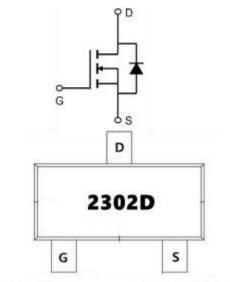
 $R_{DS(ON)} < 65m\Omega @ V_{GS}=10V$ (Type: 52m Ω)

Application

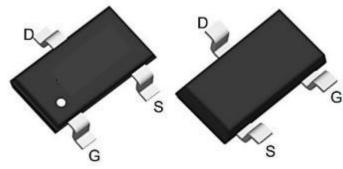
Battery protection

Load switch

Uninterruptible power supply



Top View Bottom View



Package Marking and Ordering Information

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	Product ID	Pack	Marking	Qty(PCS)
	CP2302DI	SOT23L	2302D	3000

Absolute Maximum Ratings (Tc=25°Cunless otherwise noted)

Symbol	Parameter	Rating	Units
V _D s	Drain-Source Voltage	20	V
Vgs	Gate-Source Voltage	±12	V
lo@Ta=25°C	Continuous Drain Current, V _{GS} @ 4.5V ¹	2.3	А
lo@Ta=70°C	Continuous Drain Current, V _{GS} @ 4.5V ¹	1.2	А
Ірм	Pulsed Drain Current ²	6.9	А
Pb@Ta=25°C	Total Power Dissipation ³	0.77	W
Тѕтс	Storage Temperature Range	-55 to 150	°C
TJ	Operating Junction Temperature Range	-55 to 150	°C
Reja	Thermal Resistance Junction-ambient ¹	125	°C/W
Rejc	Thermal Resistance Junction-Case ¹	100	°C/W





Electrical Characteristics (T_J=25°C, unless otherwise noted)

Symbol	Parameter	Test Condition	Min.	Тур.	Max.	Units
V(BR)DSS	Drain-Source Breakdown Voltage	Vgs=0V,Ip=250µA	20	22	-	V
IDSS	Zero Gate Voltage Drain Current	V _{DS} =20V, V _{GS} = 0V,	-	-	1.0	μA
IGSS	Gate to Body Leakage Current	V _{DS} =0V,V _{GS} = ±12V	-	-	±100	nA
VGS(th)	Gate Threshold Voltage	VDS= VGS, ID=250µA	0.5	0.65	1.2	V
DD0()	Static Drain-Source on-Resistance note2	Vgs =4.5V, ID =3A	-	52	65	mΩ
RDS(on)		Vgs =2.5V, ID =2A	-	75	90	
Ciss	Input Capacitance		-	150	-	pF
Coss	Output Capacitance	V _{DS} =10V, V _{GS} =0V, f = 1.0MHz	-	34	-	pF
Crss	Reverse Transfer Capacitance		-	26	-	pF
Qg	Total Gate Charge		-	2.4	-	nC
Qgs	Gate-Source Charge	V _{DS} =10V, I _D =3A, V _{GS} =4.5V	-	0.88	-	nC
Qgd	Gate-Drain("Miller") Charge		-	0.77	-	nC
td(on)	Turn-on Delay Time	V _{DS} =10V, b=3A, R _{GEN} =3Ω, V _{GS} =4.5V	-	6.8	-	ns
tr	Turn-on Rise Time		-	57	-	ns
td(off)	Turn-off Delay Time		-	14	-	ns
t f	Turn-off Fall Time		-	53	-	ns
IS			-	-	2.3	Α
ISM			-	-	6.8	Α
VSD	Drain to Source Diode Forward Voltage	V _{GS} = 0V, I _S =3A	-	-	1.3	V

Note

- 1. The data tested by surface mounted on a 1 inch² FR-4 board with 2OZ copper.
- 2 . The data tested by pulsed , pulse width $\leq 300 \text{us}$, duty cycle $\leq 2\%$
- 3 . The power dissipation is limited by $150\,^\circ\!\mathrm{C}$ junction temperature
- $4\sqrt{100}$ The data is theoretically the same as $10\sqrt{100}$ and $10\sqrt{100}$, in real applications, should be limited by total power dissipation.



Typical Characteristics

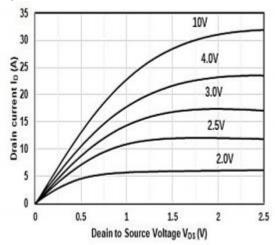


Figure 1. Output Characteristics

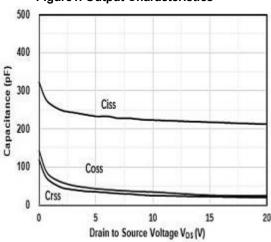


Figure 3. Capacitance Characteristics

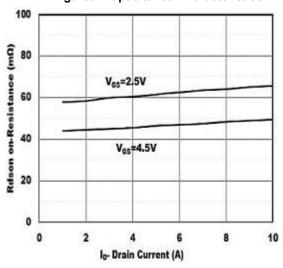


Figure 5. Drain-Source on Resistance

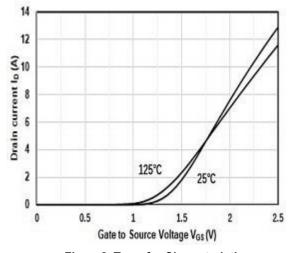


Figure 2. Transfer Characteristics

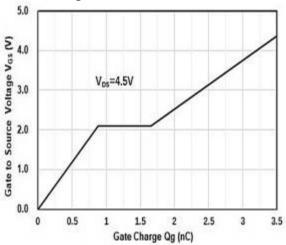


Figure4. Gate Charge

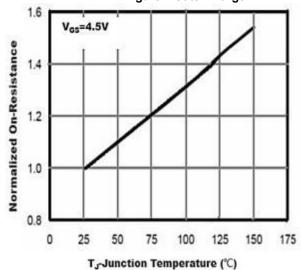
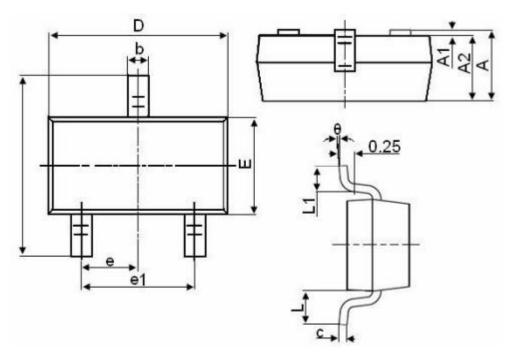


Figure 6. Drain-Source on Resistance



Package Mechanical Data-SOT23-XC-Single



Symbol	Dimensions in Millimeters		
	MIN.	MAX.	
Α	0.900	1.150	
A1	0.000	0.100	
A2	0.900	1.050	
b	0.300	0.500	
С	0.080	0.150	
D	2.800	3.000	
Е	1.200	1.400	
E1	2.250	2.550	
е	0.950TYP		
e1	1.800	2.000	
L	0.550REF		
L1	0.300	0.500	
θ	0°	8°	



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CP2302DI 20V N-Channel Enhancement Mode MOSFET

Edition	Date	Change
Rve1.0	2022/1/1	Initial release

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